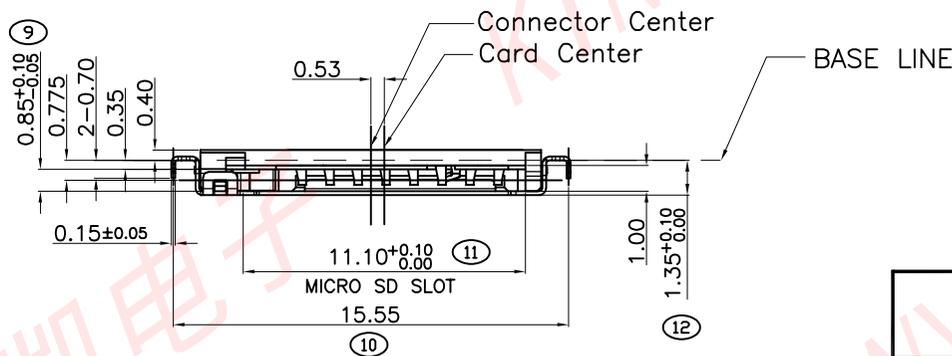
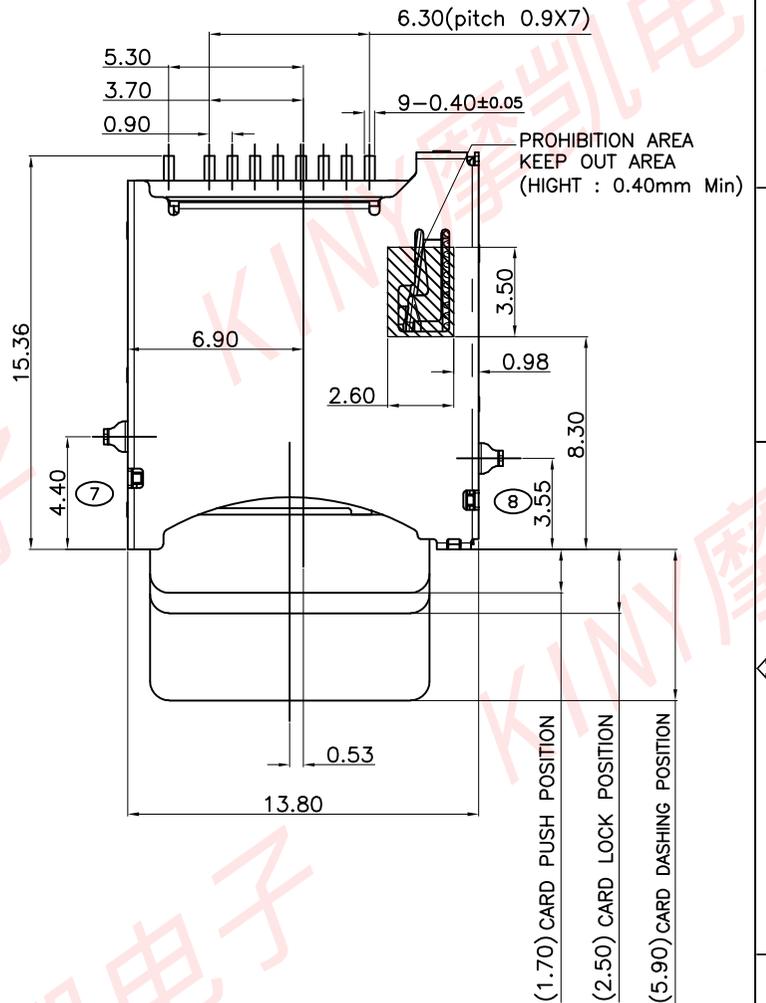
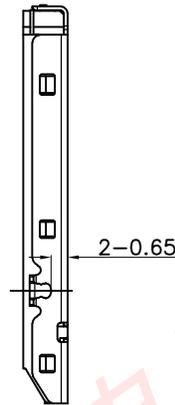
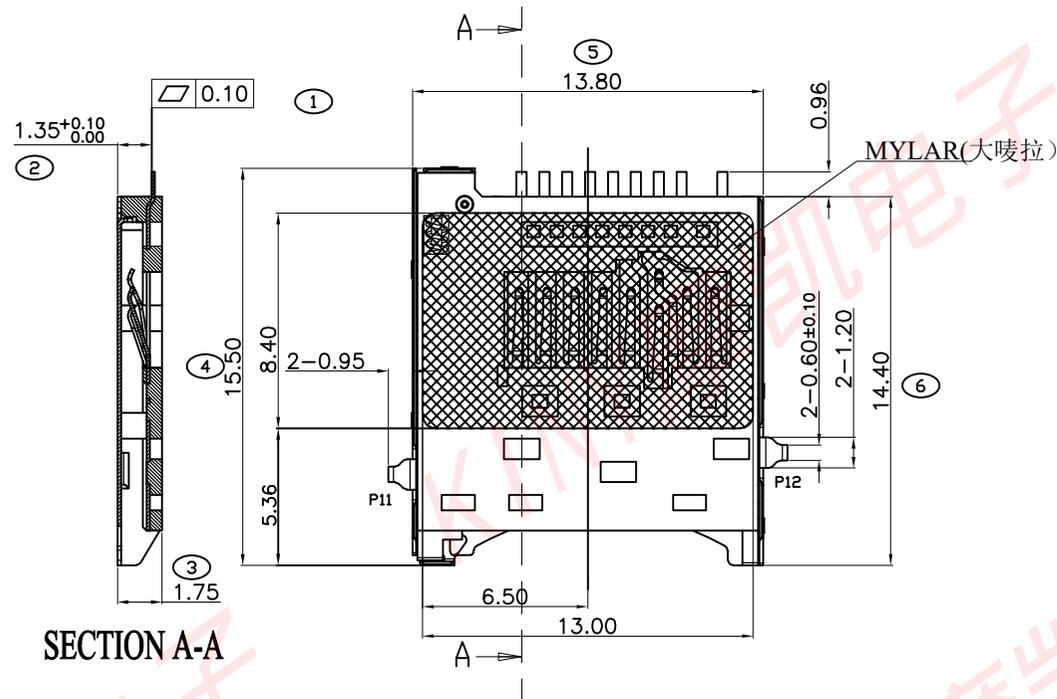


* 所有原料材质, 生产制程, 电镀必须符合IP要求



SECTION A-A

KINY

东莞市摩凯电子有限公司

DIMENSIONS INIT: mm
UNLESS OTHERWISE SPECIFIABLE

DIMENSION	TOLERANCE
X.X: ±	0.35
X.XX: ±	0.25
X.XXX: ±	0.10
ANGULAR: ±	2'

PRODUCT NAME :
MICRO SD 板下沉板1.35mm 主体加厚0.3

PRODUCT NO. :
MS135-T1230-51

DRAWING NO. :
D-MS135-T1230-51

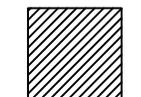
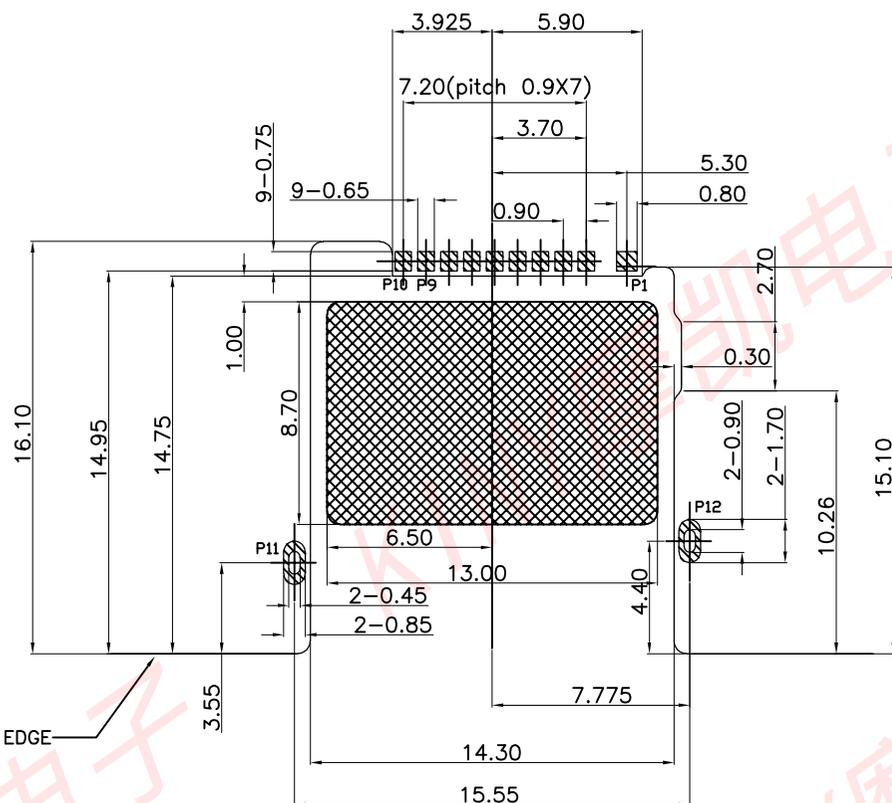
DRAWING: Jack	DATE: 2021.02.22
CHECK: Alex	DATE: 2021.02.22
APPROVED: Alex	DATE: 2021.02.22



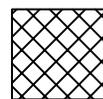
SCALE: 1:1	DWG ID: C D	REV.:	PAGE: 1 of 2
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REVISION NO.	ECR NO.	DESCRIPTION	MARK	DATE
A	---	NEW RELEASE	Jack	2021.02.22

* 所有原料材质, 生产制程, 电镀必须符合HSE要求

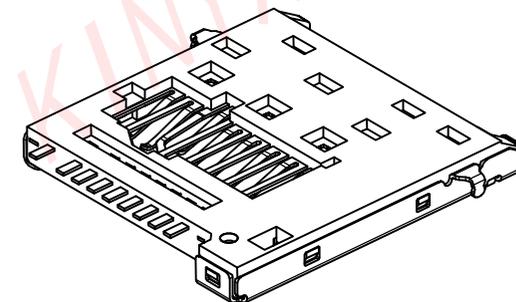


PAD AREA



NO COPPER AREA

Pin Define	
P1	SWITCH TERM CD
P2	DAT1
P3	DAT0
P4	VSS
P5	CLK
P6	VDD
P7	CMD
P8	CD/DAT3
P9	DAT2
P10	GND
P11	GND
P12	GND



PCB PATTERN LAYOUT

(GENERAL TOLERANCE: ±0.05)

Specification

*Electrical Characteristics:

Contact Current Rating: 0.5Amperes.
Dielectric Withstanding Voltage: AC500V r.m.s.
Insulation Resistance: 1000 Megohms
Minimum At DC 500V.
Contact Resistance: 100 mΩ Maximum.

*Mechanical Characteristics:

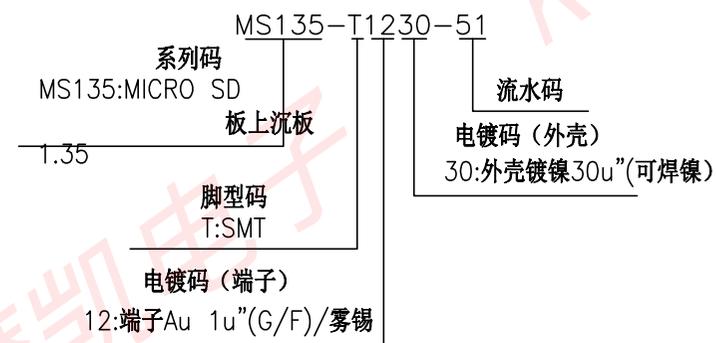
Mating Cycles: 10,000 Cycles.

*Environmental:

Operating Temperature: -25°C ~ +85°C.

*Materials:

Insulator: HI-Temp plastic UL 94V-0 Rated.
Contact: Copper Alloy.
Shell: Stainless Steel (t=0.15mm).



东莞市摩凯电子有限公司

DIMENSIONS INIT: mm UNLESS OTHERWISE SPECIFIABLE DIMENSION TOLERANCE X.X: ± 0.35 X.XX: ± 0.25 X.XXX: ± 0.10 ANGULAR: ± 2'	PRODUCT NAME : MICRO SD 板下沉板1.35mm 主体加厚0.3	DRAWING: Jack	DATE: 2021.02.22
	PRODUCT NO. : MS135-T1230-51	CHECK: Alex	DATE: 2021.02.22
	DRAWING NO. : D-MS135-T1230-51	APPROVED: Alex	DATE: 2021.02.22
	SCALE: 1:1	DWG ID: C D	REV.: A

A	-----	NEW RELEASE	Jack	2021.02.22
REVISION NO.	ECR NO.	DESCRIPTION	MARK	DATE
1				
2				
3				